

Microchip**Filter specification****TFS1920B****1/5****Measurement condition**

Ambient temperature T_A :	23	°C
Input power level:	0	dBm
Terminating impedance:		
Input:	50	Ω
Output:	50	Ω

Characteristics

Remark:

The maximum attenuation in the pass band is defined as the insertion loss a_e . The nominal frequency f_N is fixed at 1920.0 MHz without any tolerance or limit. The values of absolute attenuation a_{abs} are guaranteed over the whole operating temperature range. The frequency shift of the filter within the operating temperature range is included in the production tolerance scheme.

D a t a		typ. value		tolerance / limit	
Insertion loss within PB		a_e	2.8 dB	max.	4.0 dB
Nominal frequency		f_N	-		1920.0 MHz
Passband		PB	-		$f_N \pm 9.0$ MHz
Pass band variation			0.6 dB		0.8 dB
Absolute attenuation		a_{abs}			
1	MHz ... 1750 MHz	45	dB	min.	40 *) dB
1750	MHz ... 1870 MHz	42	dB	min.	35 dB
1870	MHz ... 1880 MHz	40	dB	min.	30 dB
1880	MHz ... 1890 MHz	26	dB	min.	15 dB
1890	MHz ... 1900 MHz	8	dB	min.	4 dB
1940	MHz ... 1950 MHz	6	dB	min.	4 dB
1950	MHz ... 1960 MHz	15	dB	min.	10 dB
1960	MHz ... 1965 MHz	40	dB	min.	30 dB
1965	MHz ... 2200 MHz	55	dB	min.	40 dB
2200	MHz ... 2500 MHz	50	dB	min.	35 dB
2500	MHz ... 3200 MHz	40	dB	min.	30 dB
3200	MHz ... 4000 MHz	35	dB	min.	25 dB
Group delay variation within PB		GDV	8 ns	max.	40 ns
Input power level			-	max.	15 dBm
Operating temperature range		OTR	-		-40 °C ... +85 °C
Storage temperature range			-		-55 °C ... +125 °C

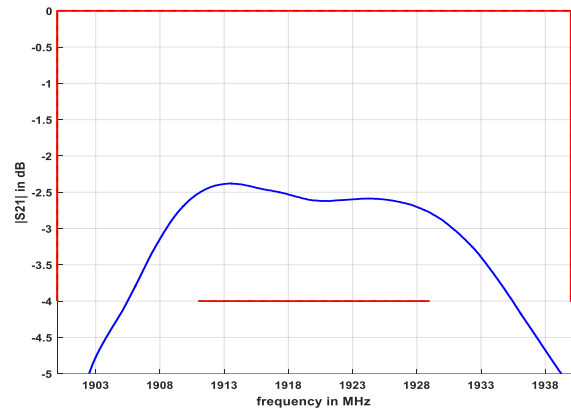
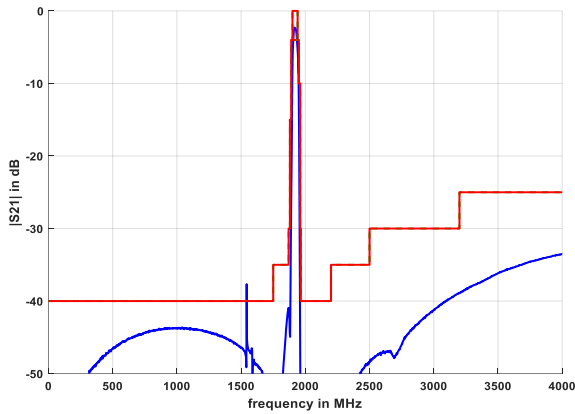
*) Spurious of up to 35 dB between 1540 MHz and 1550 MHz with 3 dB bandwidth < 1 MHz.

Generated:**Checked / Approved:**

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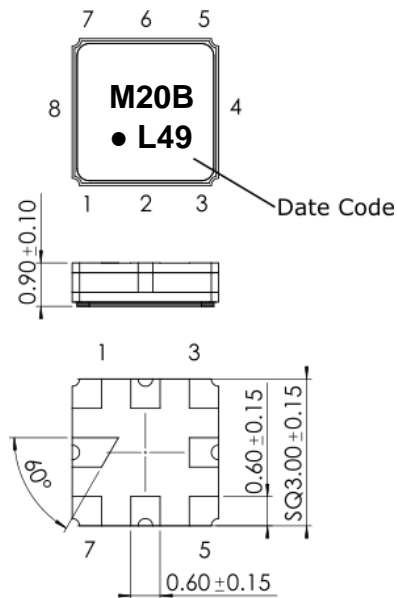
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Filter characteristic



Construction and pin connection

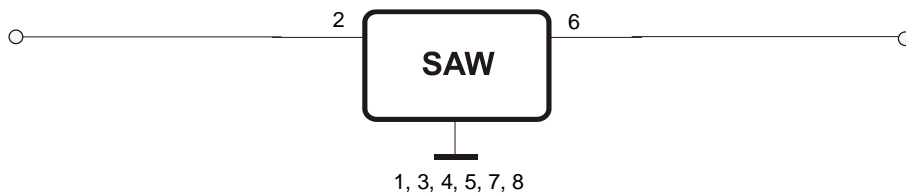
(All dimensions in mm)



- 1 Ground
- 2 Input
- 3 Ground
- 4 Ground
- 5 Ground
- 6 Output
- 7 Ground
- 8 Ground

Date code: Year + week
 L 2019
 M 2020
 N 2021
 ...

50 Ω Test circuit



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Stability characteristics, reliability

After the following tests the filter shall meet the whole specification:

1. Shock: 500 g, 1 ms, half sine wave, 3 shocks each plane;
DIN IEC 60068 T2 - 27
2. Vibration: 10 Hz to 2000 Hz, 0.35 mm or 5 g respectively, 1 octave per min, 10 cycles per plane, 3 planes; DIN IEC 60068 T2 - 6
3. Change of temperature: -55 °C to 125 °C / 15 min. each / 100 cycles
DIN IEC 60068 part 2 – 14 Test N
4. Resistance to solder heat (reflow): reflow possible: three times max.;
for temperature conditions refer to the attached "Air reflow temperature conditions" on page 4;
5. SAW devices are Electrostatic Discharge (ESD) sensitive devices.

This filter is RoHS compliant (2011/65/EU)

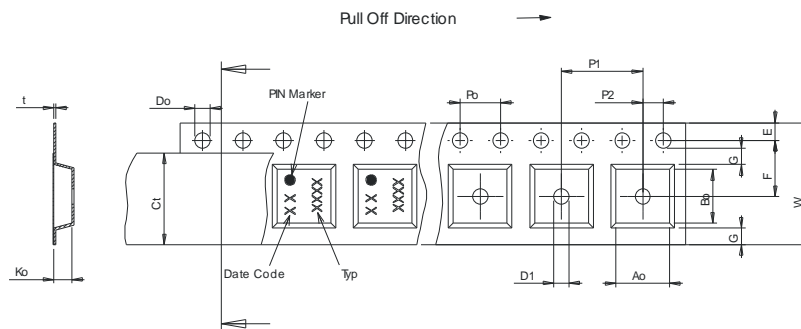
Packing

Tape & Reel: IEC 286 – 3, with exception of value for N and minimum bending radius;
tape type II, embossed carrier tape with top cover tape on the upper side;

reel of empty components at start:	min. 300 mm
reel of empty components at start including leader:	min. 500 mm
trailer:	min. 300 mm

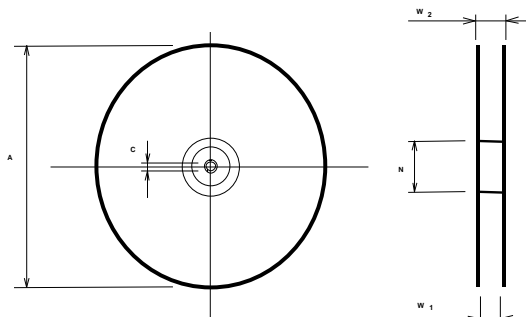
Tape (all dimensions in mm)

- W : 8.00 ±0.3
- Po : 4.00 ±0.1
- Do : 1.50 +0.1/-0
- E : 1.75 ±0.1
- F : 3.50 ±0.05
- G(min) : 0.75
- P2 : 2.00 ±0.05
- P1 : 4.00 ±0.1
- D1(min) : 1.50
- Ao : 3.25 ±0.1
- Bo : 3.25 ±0.1
- Ct : 5.30 ±0.1
- Ko : 1.50 ±0.1
- t : 0.25 ±0.05



Reel (all dimensions in mm)

- A : 330 or 180
- W1 : 8.40 +1.5/-0
- W2(max) : 14.40
- N(min) : 60.00
- C : 13.0 ±0.2



The minimum bending radius is 45 mm.

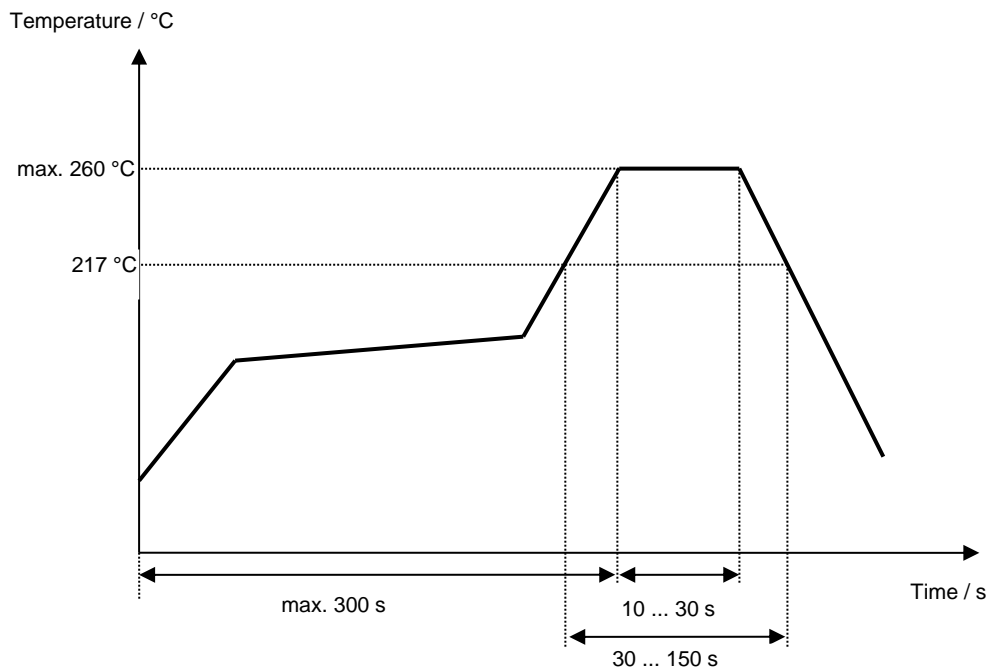
Air reflow temperature conditions

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Conditions	Exposure
Average ramp-up rate (30 °C to 217 °C)	less than 3 °C / second
> 100 °C	between 300 and 600 seconds
> 150 °C	between 240 and 500 seconds
> 217 °C	between 30 and 150 seconds
Peak temperature	max. 260 °C
Time within 5 °C of actual peak temperature	between 10 and 30 seconds
Cool-down rate (Peak to 50 °C)	less than 6 °C / second
Time from 30 °C to Peak temperature	no greater than 300 seconds

Chip-mount air reflow profile



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Microchip**Filter specification****TFS1920B****5/5**

History

Version	Reason of Changes	Name	Date
1.0	Generation of development specification.	P. Jaster	06.08.2019
2.0	Generation of filter specification.	Schönbein	04.12.2019

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